TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VHCT240AF,TC74VHCT240AFT,TC74VHCT240AFK TC74VHCT244AF,TC74VHCT244AFT,TC74VHCT244AFK

Octal Bus Buffer

TC74VHCT240AF/AFT/AFK Inverted, 3-State Outputs

TC74VHCT244AF/AFT/AFK
Non-Inverted, 3-State Outputs

The TC74VHCT240A and 244A are advanced high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate C<sup>2</sup>MOS technology. They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The TC74VHCT240A is an inverting 3-state buffer having two active-low output enables. The TC74VHCT244A is a non-inverting 3-state buffer, and has two active-low output enables

These devices are designed to be used with 3-state memory address drivers, etc.

The input voltage are compatible with TTL output voltage.

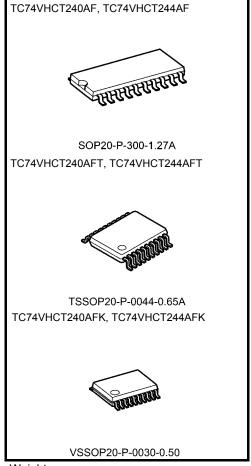
These devices may be used as a level converter for interfacing 3.3 V to 5 V system.

Input protection and output circuit ensure that 0 to 5.5~V can be applied to the input and output  $^{\rm (Note)}$  pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, hot board insertion, etc.

Note: Output in off-state

#### **Features**

- High speed:  $t_{pd} = 6.1 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_a = 25 \text{°C}$
- Compatible with TTL inputs: VIL = 0.8 V (max)VIH = 2.0 V (min)
- · Power down protection is provided on all inputs and outputs
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Low noise: VOLP = 1.0 V (max)
- Pin and function compatible with the 74 series (74AC/HC/F/ALS/LS etc.) 240/244 type.

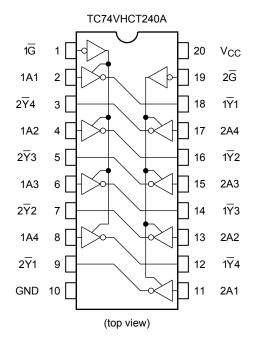


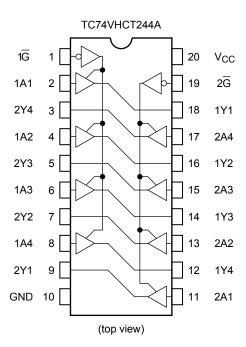
Weight

SOP20-P-300-1.27A: 0.22 g (typ.) TSSOP20-P-0044-0.65A: 0.08 g (typ.) VSSOP20-P-0030-0.50: 0.03 g (typ.)

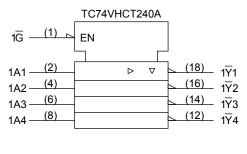


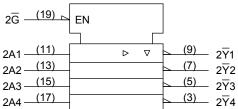
## **Pin Assignment**

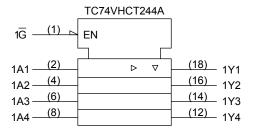


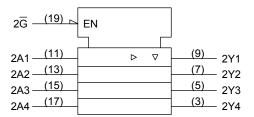


#### **IEC Logic Symbol**









#### **Truth Table**

Inputs		Outputs				
G	An	Yn	$\overline{Y}_n$			
L	L	L	Н			
L	Н	Н	L			
Н	Х	Z	Z			

X: Don't care

Z: High impedance

Yn: TC74VHCT244A  $\overline{Y}_n$ : TC74VHCT240A

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#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	−0.5 to 7.0	V
DO control to the con-	Vour	-0.5 to 7.0 (Note 2)	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5 (Note 3)	V
Input diode current	I <sub>IK</sub>	-20	mA
Output diode current	lok	±20 (Note 4)	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±75	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in off-state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: Vout < GND, Vout > Vcc

### **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	4.5 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	V	0 to 5.5 (Note 2)	V	
Output voltage	Vout	0 to V <sub>CC</sub> (Note 3)	V	
Operating temperature	T <sub>opr</sub>	–40 to 85	°C	
Input rise and fall time	dt/dV	0 to 20	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V<sub>CC</sub> or GND.

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Note 2: Output in off-state

Note 3: High or low state



## **Electrical Characteristics**

### **DC Characteristics**

Characteristics Symbol		Test Condition V <sub>CC</sub> (V		_	Ta = 25°C			Ta = -40 to 85°C		Unit
				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
High-level input voltage	V <sub>IH</sub>	_		4.5 to 5.5	2.0	_	_	2.0	_	V
Low-level input voltage	V <sub>IL</sub>	_		4.5 to 5.5	_	_	0.8	_	0.8	V
High-level output	V	V <sub>IN</sub>	I <sub>OH</sub> = -50 μA	4.5	4.40	4.50	_	4.40	_	V
voltage	V <sub>OH</sub>	$= V_{IH} \text{ or } V_{IL}$	I <sub>OH</sub> = -8 mA	4.5	3.94	_	_	3.80	_	
Low-level output	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OL} = 50 \mu A$	4.5	_	0.0	0.10	_	0.10	٧
voltage			I <sub>OL</sub> = 8 mA	4.5	_	_	0.36	_	0.44	
3-state output off-state current	I <sub>OZ</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = V_{CC}$ or GND		5.5	_	_	±0.25	_	±2.50	μА
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	_	_	±0.1	_	±1.0	μА
Icc		V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	4.0	_	40.0	μА
Quiescent supply current	Ісст	Per input: V <sub>IN</sub> = 3.4 V Other input: V <sub>CC</sub> or GND		5.5	_	_	1.35	_	1.50	mA
Output leakage current	I <sub>OPD</sub>	V <sub>OUT</sub> = 5.5 V		0	_	_	0.5	_	5.0	μА



### AC Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics Symbol		Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
3,		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max		
Propagation delay time	t <sub>pLH</sub>	_	5.0 ± 0.5	15	_	5.6	7.8	1.0	9.0	ns
(TC74VHCT240A)	$t_{pHL}$		0.0 ± 0.0	50	_	6.1	8.8	1.0	10.0	113
Propagation delay time	t <sub>pLH</sub>	_	5.0 ± 0.5	15	_	5.4	7.4	1.0	8.5	ns
(TC74VHCT244A)	$t_{pHL}$		J.U ± 0.5	50	_	5.9	8.4	1.0	9.5	
3-state output enable time tpZL tpZH	t <sub>pZL</sub>	$R_L = 1 \text{ k}\Omega$	5.0 ± 0.5	15	_	7.7	10.4	1.0	12.0	- ns
	$t_{pZH}$			50	_	8.2	11.4	1.0	13.0	
3-state output disable time	t <sub>pLZ</sub> t <sub>pHZ</sub>	$R_L = 1 \text{ k}\Omega$	5.0 ± 0.5	50	_	8.8	11.4	1.0	13.0	ns
Output to output skew	t <sub>osLH</sub>	(Note 1)	5.0 ± 0.5	50	_	_	1.0	_	1.0	ns
Input capacitance	C <sub>IN</sub>	_		_	4	10	_	10	pF	
Output capacitance	C <sub>OUT</sub>	_		_	9	_	_	_	pF	
Power dissipation capacitance (Note 2)	C <sub>PD</sub> TC74VHCT240A				_	19	_	_	_	pF
	ΨPD	TC74VHCT244A			_	18	_	_	_	ρ'

Note 1: Parameter guaranteed by design.

$$t_{\text{OSLH}} = |t_{\text{pLHm}} - t_{\text{pLHn}}|, \ t_{\text{OSHL}} = |t_{\text{pHLm}} - t_{\text{pHLn}}|$$

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

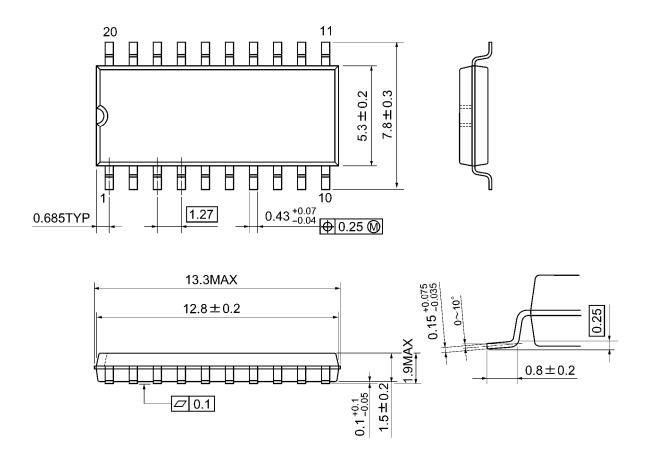
#### Noise Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C		Unit
			V <sub>CC</sub> (V)	Тур.	Limit	Offic
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.8	1.0	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.8	-1.0	>
Minimum high level dynamic input voltage	$V_{IHD}$	C <sub>L</sub> = 50 pF	5.0	ı	2.0	>
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	_	0.8	٧



## **Package Dimensions**

SOP20-P-300-1.27A Unit: mm

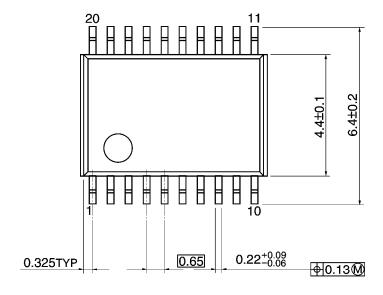


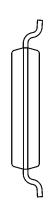
Weight: 0.22 g (typ.)

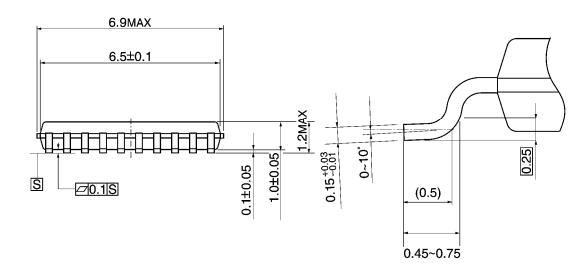
## **Package Dimensions**

TSSOP20-P-0044-0.65A

Unit: mm



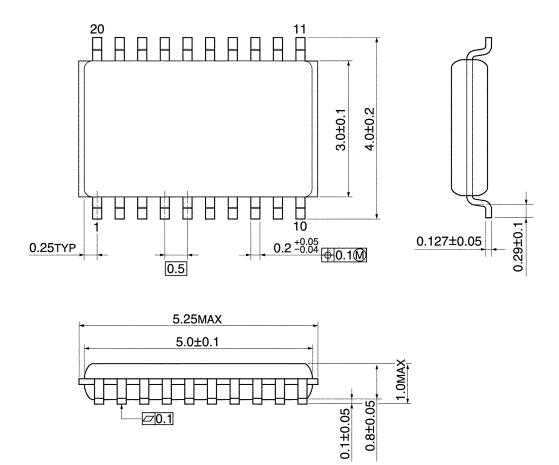




Weight: 0.08 g (typ.)

## **Package Dimensions**

VSSOP20-P-0030-0.50 Unit: mm



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Weight: 0.03 g (typ.)



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